

## **RoHS Statement**

## EU Regulation 2011/65/EU, 2015/863/EU

To Whom it May Concern,

Owasys Advanced Wireless Devices S.L. hereby declares that all Owasys' products placed on the European Community market are compliant with the European Union directive 2011/65/EU (RoHS II) with amendment 2015/863/EU (sometimes referred to as RoHS III).

Homogeneous materials have a maximum concentration by weight according to the list below:

- Lead (0.1%)
- Mercury (0.1%)
- Cadmium (0.01%)
- Hexavalent Chromium (0.1%)
- Polybrominated Biphenyls (PBB) (0.1%)
- Polybrominated Diphenyl Ethers (PBDE) (0.1%)
- Bis (2-ethylhexyl) Phthalate (DEHP) (0.1%)
- Butyl Benzyl Phthalate (BBP) (0.1%)
- Dibutyl Phthalate (DBP) (0.1%)
- Di-isobutyl Phthalate (DIBP) (0.1%)

Owasys' products do not exceed any of the above substances' limits except lead. When that is a case, one of the following exemptions may apply:

- 6(c) Copper alloy containing up to 4% lead by weight.
- 7(a) Lead in high melting temperature type solders (i.e. lead-based alloys containing 86% by weight or more lead).
- 7(c)- I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezo electronic devices, or in a glass or ceramic matrix compound.

This statement represents the company's knowledge and belief which is partially based on information provided by third party suppliers. If you have any questions regarding product stewardship, please contact <a href="mailto:compliance@owasys.com">compliance@owasys.com</a>.

Owasys reserves the right to change the information stated in this document without any further notice.

**J**avier **G**urtubay Managing Director

24 January 2025